

**20 April 1999
DRAFT**

**Quality Assurance
for ATLAS MDT Chamber Construction**

Task Owner QA/QC Procedures

Description of the Quality Assurance Procedures for the Construction
of the Monitored Drift Tube chambers for the ATLAS muon spectrometer.

Table 1: Quality control tests of drift tube materials at the character production sites

Test	Acceptance criteria	Reaction if failed	Date last comment
Aluminum tube			
Visual inspection of inside and outside	no obvious defects or holes; proper cleaning, straightness, bare cycle, packing	reject,通知生产商	central 1: suitable test batch 2: early tube before writing
Outer diameter envelope, from S (reduces to character diameter)	2307(+) - 15 mm	reject, box	central suitable test batch
Wall thickness, at 8 points on circumferenc	13.0 - 30 µm	reject, box	central suitable test batch
Length, l	$l = 3.5$ mm ($l \leq 1.6$) $l = 3.7$ mm ($l > 1.6$)	reject, box	central suitable test batch
Straightness	insertion in $\frac{1}{2}$ without difficulties	reject, tube, notify supplier	central suitable test batch
Wire			
Visual inspection	no defects of gold-plating; proper cleaning, no kinds	reject, reject	central 1: first tube after writing 2: first tube after writing for second tube after writing
Folding			
Visual inspection	proper cleaning and no obvious defects of flexible, flexible wire, electron. After forming and bending, eliminate the	reject,通知生产商	central 1: suitable test batch 2: early tube before writing
Outer diameter envelope, from S (reduces to character diameter) (optional)	3329(+) - 15 mm	reject, batch	central suitable test batch
Wire location outer diameter	within tolerance	reject, batch	central suitable test batch

Table 3: Quality control tests of drift tubes at the chamber production sites

Test	Acceptance criteria	Reaction if failed	Time base	Comment
Drift tube				
Visual inspection	no obvious damage of tube or endpin, no visible defects of tube and wire crimp, tube correctly sealed	reject tube, adjust wiring station	local	each tube after wiring, before chamber assembly
Aluminum tube outer diameter acceptance in stretching region	less than 30.322 mm	adjust wiring setup	local	sample test/day after wiring
Length l_c	$l_c = 3.5 \text{ mm}$ $40.23 - 1.5^\circ \text{ C}$	reject drift tube, adjust wiring station	local	1: sample test/day ≥ each tube on chamber assembly [1]
Relative additional orientation of endpins	-1.5° max	reject drift tube, adjust wiring station	local	1: sample test/day ≥ each tube on chamber assembly [1]
Straightness	insertion in Σ_2 without difficulties	reject drift tube	local	1: sample test/day ≥ each drift tube during chamber assembly
Ground contact resistance ρ_g	less than $1.0 \text{ m}\Omega$	reject, laser welding	local	1: sample test/day ≥ monitoring of selected tubes over time

Table 3: Quality control tests for all drift tubes at the chamber production sites

Test	Acceptance criteria	Action if failed	Date base	Comment
Drift tube				
External temperature	20 – 25 °C	adjust	local	during tube tests
Relative humidity (optional)			local	monitoring
Temperature of tube	20 – 15 °C	adjust temperature on tension	local	during tube assembly
Temperature of tube	known within $\pm 1^\circ\text{C}$	repeat measurement	central	during wire tension measurement
Wire tension (oscillation frequency)	within $\pm 5\%$ of the nominal value at 20 – 15 °C	reject drift tube	central	1: shortly after tube wiring 2: after min. two months before assembly
Wire location at the tube ends	within ± 25 µm of the center of the endflange ref. surface in α and β	reject drift tube; inspect endflanges and wiring station	central	sample test on day of wiring; tube held as in assembly [2]; incl. test of readability of endflanges; measurements at 3 and 18 °C
Pressure leak at 3 bar overpressure	no obvious leaks	reject drift tube; inspect endflanges; adjust wiring station	local	before leak test
Leak rate at ± 2 bar overpressure	less than 10^{-8} bar/l/s	reject drift tube; inspect endflanges; tighten wire	central	
IV stability test: leakage current	less than $\pm 10\text{nA}/\text{fm}$	reject drift tube; inspect endflanges; tighten wire	central	with Ar/CO ₂ (33:7) at 3 bar and 31CO ₂ (1:3) at 3 bar gain
IV stability test: resistive conduct. ratio (optional)	within $\pm 3\%$ of nominal value	reject drift tube; inspect endflanges; tighten wire	central	with Ar/CO ₂ (33:7) at 3 bar and 31CO ₂ (1:3) at 3 bar gain

Table 4: Brief test equipment at the production sites

Site	Wire tension (freq., frequency)	Wire position	Leak rate (whole tube)	UV test (leakage current)	UV test (concrete rate)
Freiburg	Excitation in B-field	Brändström N-tay system	Leak detector with single-tube containers	UV system with leak detector	Yes
LMU/FMP1 (excep. 1st fl.)	CALIN SV7012 meter; excitation in B-field	Brändström N-tay system, Milj 32	Pressure rise in evacuated volume at shelving (8 tubes sim.)	UV system with 1 nA sensitivity	UV system; shaper
NTU/Athenae	CALIN SV7012 meter; excitation in B-field	Brändström N-tay system	Leak detector, single-tube container	As FMP1 (single-tube)	
Univ. Athens			As NTU Athens (after module 3)		
Theessinkiki (excep. 1st fl.)	Excitation in B-field			CALIN SV127 (10 channels); 1 nA sensitivity UV system	
Freestati	Electrovacuum test, multi-channel system, integration with leak test.	Electron gun test; as Paria/tarne	Leak detector, 3) single-tube containers	CALIN SV715 (20 channel); 1 nA sensitivity UV system;	Yes
Conecta	CALIN SV7012 meter; excitation in B-field integration with leak test.	Electron gun test; as Paria/tarne	Leak detector integration with leak test.	CALIN SV715 (20 channel); 1 nA sensitivity UV system;	
Paris	As Roma	Electron gun test; (IMMI)	Argon mass (separated); 1) single-tube containers (commercial system)	UV system (12 channels) with leak meter; integration with leak test.	
Roma	Excitation in B-field; multi-channel	Electron gun test; (IMMI)	As Paria/tarne	As Paria	
NIRHEF	Mechanical excitation; piezoelectric measurement	Electron gun test; as Paria/tarne	Leak detector; multil-tube container	Multichannel UV system; integration with leak test.	Yes
Dubna	Excitation in B-field; meter custom design (also for KMI)	Brändström N-tay system, Milj 32	Leak detector; multil-tube containers	CALIN SV715 (20 channel); 1 nA sensitivity UV system	UV system; shaper
Pretoria	Excitation in B-field; meter custom design	Brändström N-tay system	Leak detector		
Boston	Excitation in B-field; meter custom design	Brändström N-tay system	Mass spectrometer; multil-tube container	Multichannel UV system; integration with leak test.	Yes
Michigan	As Seattle	Electron gun test; as Paria/tarne	Leak detector; vacuumed volume aband- eling and moving along tube	Multichannel UV system	
Seattle	Excitation in B-field; meter custom design	Electron gun test; as Paria/tarne	As Michigan		

Table 5: Quality control measurements during chamber assembly.

Test	Acceptance criteria	Action if failed	Data base	Comment
Environment				
Room temperature	20 ± 1.5 °C	adjust	local	before gluing
Relative humidity	50 ± 10 %	adjust	local	before gluing
Atmospheric pressure (optional)			local	monitoring
Temperature of chamber	20 ± 0.5 °C	adjust	local	before gluing
Temperature of jigs/g	20 ± 0.5 °C	adjust	local	before gluing
Temperature difference between chamber and jig	< 0.25 °C	adjust	local	before gluing
Spacer assembly				
Gap width between filter on ends and cross plates	200 – 1333 µm	adjust	local	both orientations of cross plates oriented correctly
On-chamber gap system				
Leak rate	less than 10 \times bar l/s	repair	local	of preassembled gap manifolds
Flow rate/filter	to be specified	repair		for preassembled gap manifolds

Table 6: Quality control measurements during chamber assembly (cont.)

Test	Acceptance criteria	Action if failed	Data base	Comment
Assembly of tube layers				
Vertical section interpressure	at nominal value	adinst.	local	Intake pressurizing air contacts during glazing
Horizontal gaps between intakes	not more than two adjacent intake walls touching, no adjacent endflaps touching	relocate drift intakes	before glazing	
Vertical position of endflap reference surfaces	-13 mm of nominal value	relocate drift intakes	local	before glazing
Siphon locations	-13 mm of nominal value	adinst.	local	before glazing
Outer cross plate gaps on the assembly table	-13 mm	adinst.	local	before glazing with siphone and in-plane membranes
Middle cross plate gap on the assembly table	-27 mm	adinst.	local	before glazing with siphone and cross plate membranes

Table 7: Quality control tests of assembled characters at the production sites

Test	Acceptance criteria	Reaction if failed	Data base	Comment
Mechanical Tests				
Sag of character with kinematical supports before sag compensation	stow data	central	o readings of in-plane members	
Sag of character on kinematical supports after sag compensation	within $\pm 2\mu m$ of wire sag	adjust sag compensation and tolerance reached, stow data	central	o readings of in-plane members
Deformation of stress plates on kinematical supports (optional)	$< 2\mu m$	stow data	central	with temporary cross plate sag members

Table 8: Quality control tests of assembled chambers at the production sites (cont.)

Test	Acceptance criteria	Action if failed	Date base	Comment
Operation Test:				
Pressure test: at 1 bar	test done; no obvious leaks	repair gas manifold; repair/disconnect fancy tubes, store 1/2	central	before leak test.
Leak rate: at 3 bar	less than 2×10^{-7} bar l/s per tube	repair gas manifold; repair/disconnect fancy tubes, store 1/2	central	
UV stability: leakage current (optional)	less than 5 nA/channel	replace electronics boards; identify spurts/disconnect fancy drift tubes, store 1/2	central	with installed electronics boards, with baseline 2/8 at 3 bar and nominal and 5% terminal 248 gain
UV stability: cosmic count rate (optional)	less than $5 \times$ nominal value	identify noisy channels, store 1/2	central	with installed electronics boards, with baseline 2/8 at 3 bar and nominal 248 gain
Operation in cosmic ray test: stated	evaluation of performance: noise level, efficiency, random rate, max. drift time, resolution vs. ε_e , uniformity local wire displacements	make chamber operational; store 1/2 of fancy tubes	central	with test electronics, with baseline 2/8 at 3 bar and nominal 248 gain
Wire location measurement with cosmic rays (optional)	no systematic deviations from expected wire grid	store wire location data and chamber 1/2, adjust assembly leveling in case of deviations	central	track reconnection in cosmic ray tower

Table D: Quality control tests of assembled chambers during storage and at CERN

Test	Acceptance criteria	Action on failure	Date base	Comment
Visual inspection	no visible damage	perform feasible repairs, mark chamber for Nrag tomograph and full leak test	acceptance test, after transport to CERN	
Leak rate at 3 bar	less than 2×10^{-8} bar l/s per tube	repair gas manifold, repair disconnected faulty tubes, store II	central	1: full leak test for one chamber per transport to CERN (acceptance test) or if visible damage of chamber 2: monitoring of pressure (calibrated transmitter) over storage time
Wire location measurement with Nrag tomograph (incl. location of wire on the alignment platforms)	$-20 \mu\text{m}$ rms in φ and z with respect to expected wire grid	store wire location data and chamber II; adjust assembly tooling in case of deviations, measure chambers since problem first detected	central	1: multiple leak/test production site 2: for chambers with expected mechanical problems
HV stability: leakage current	less than 7 nA/channel	replace electronics boards, identify disconnected faulty tubes, store II	central	after mounting of final electronics with baseline gas at 3 bar and nominal and 2x nominal gas gain
Operating test	evaluation of performance: transient current, connections, signals from all channels, noise level, random rate, uniformity	replace electronics, make chamber operational	local	after mounting of final electronics with baseline gas at 3 bar and nominal operating conditions
Wire tension (pos., frequency)	within $\pm 5\%$ of the nominal value at green temperature	store data, modify production sites; measure other chambers	central	for one chamber/production site at regular intervals over storage time (operating temp. to $+1^\circ\text{C}$)
Tube ground contact resistance	less than 100 mΩ	store data, modify production sites; measure other chambers	central	for one chamber/production site at regular intervals over storage time